

PAD AREA

 CONNECT AREA

 KEEP OUT AREA

 GND PATTERN ONLY

RECOMMEND PCB LAYOUT
TOLERANCE: ±0.05

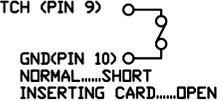
MICRO SD	
PIN1	DAT2
PIN2	CD/DAT3
PIN3	CMD
PIN4	VDD
PIN5	CLK
PIN6	VSS
PIN7	DAT0
PIN8	DAT1
PIN9	CD
PIN10	GND

MATERIALS

1. HOUSING :LCP BLACK, (UL 94V-0).
2. TERMINAL : C5210R-SH,T=0.10±0.01mm,Ni 30u",Au 1u"
3. SHELL : 304-1/2H,T=0.10±0.01mm,Ni 50u",Au 1u"
3. DETECT PIN:SUS301-1/2H,Ni 50u",Au 1u"

SPECIFICATION

1. CURRENT RATING : 0.5 A. MAX.
2. DIELECTRIC WITHSTANDING VOLTAGE :
500V AC R.M.S. FOR 1 MINUTE.
3. INSULATION RESISTANCE : 1000MΩ MIN.AT 500V DC.
4. CONTACT RESISTANCE : 100mΩ MAX.
5. OPERATING LIFE: 3000 CYCLES.
6. Salt condition for 48hours.
7. OPERATING TEMPERATURE : -40°C TO +85°C.
8. CIRCUIT DIAGRAM FOR CARD DETECT SWITCH



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TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2' X.X' ±0.5'	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: TF内焊 NO PUSH 1.3H 带检测P	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	LXW-TF-13
UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱敏	DATE : 2014-02-23	MOLD NO.	
			DRAW NO:	
			SHEET NO.	1 OF 1